

RoHS

COMPLIANT

HALOGEN

Vishay Siliconix

## N-Channel 40-V (D-S) MOSFET

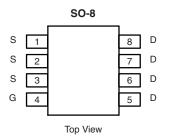
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
40	0.0038 at V <sub>GS</sub> = 10 V	33	37.5 nC			
	0.0045 at V <sub>GS</sub> = 4.5 V	31	37.5110			

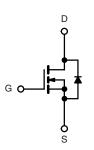
#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Available
- TrenchFET<sup>®</sup> Gen II Power MOSFET
- 100 % R<sub>a</sub> and UIS Tested

#### **APPLICATIONS**

- Secondary Rectification
- · Point of Load





Ordering Information: Si4456DY-T1-E3 (Lead (Pb)-free) Si4456DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> T <sub>A</sub> = 25 °C, un	less otherwise	e noted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	40	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		33		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1-	27		
Continuous Drain Current (1) = 150°C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	23 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		18 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	70	A	
	T <sub>C</sub> = 25 °C	L.	7.0		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.0 <sup>b, c</sup>		
Avalanche Current		I <sub>AS</sub>	40		
Single Pulse Avalanche Energy	Avalanche Energy L = 0.1 mH		80	mJ	
	T <sub>C</sub> = 25 °C		7.8		
Maximum Davier Disaination	T <sub>C</sub> = 70 °C	Р	5.0	10/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub> —	3.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	29	35	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	13	16	0/10		

Notes:

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 80 °C/W.

a. Based on T<sub>C</sub> = 25 °C.

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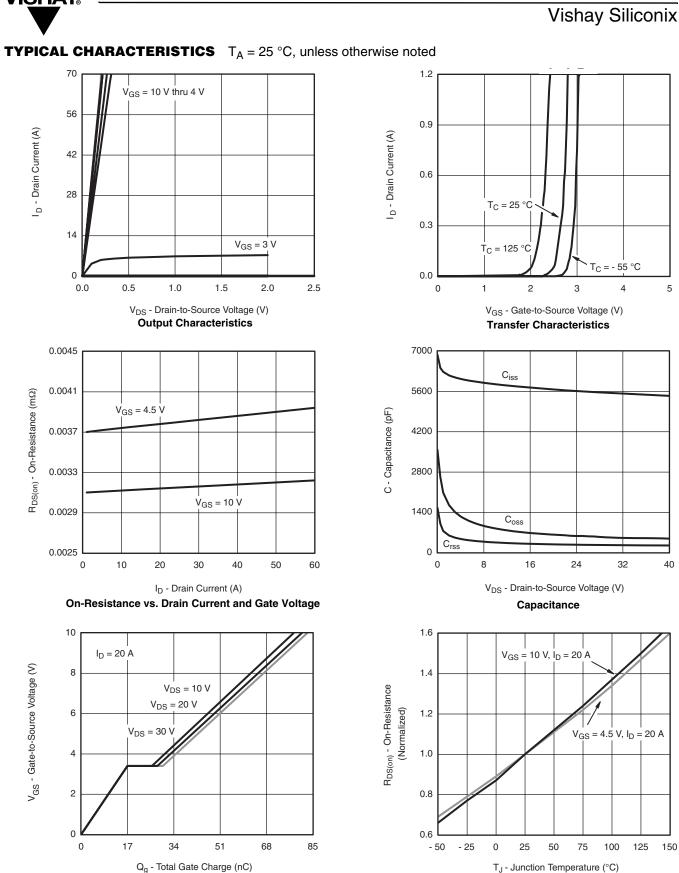
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	•	•		•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			54		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 <sub>D</sub> = 250 μΑ		- 7		mv/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.5		2.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	1 10 μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			A	
	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0031 0.0038			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		0.0037	0.0045	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		110		S	
Dynamic <sup>b</sup>		•					
Input Capacitance	C <sub>iss</sub>			5670			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		621		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			287		1 .	
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		81	122		
				37.5	57		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		17		nC	
Gate-Drain Charge	Q <sub>qd</sub>	1		11			
Gate Resistance	R <sub>q</sub>	f = 1 MHz		1.05	1.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			145	220		
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$		208	320	1	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{a}} = 1 \Omega$		56	85		
Fall Time	t <sub>f</sub>			15	23		
Turn-On Delay Time	t <sub>d(on)</sub>			21	32	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$		58	90		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		55	85		
Fall Time	t <sub>f</sub>			8	15		
Drain-Source Body Diode Characterist	ics	•			•	L	
Continous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			7		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	-			70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A		0.71	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$t_{rr}$ $Q_{rr}$ $t_a$ $I_F = 13 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, } T_J = 25 ^{\circ}\text{C}$		38	60	ns	
Body Diode Reverse Recovery Charge				42	65	nC	
Reverse Recovery Fall Time				21		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			17			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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40

Si4456DY

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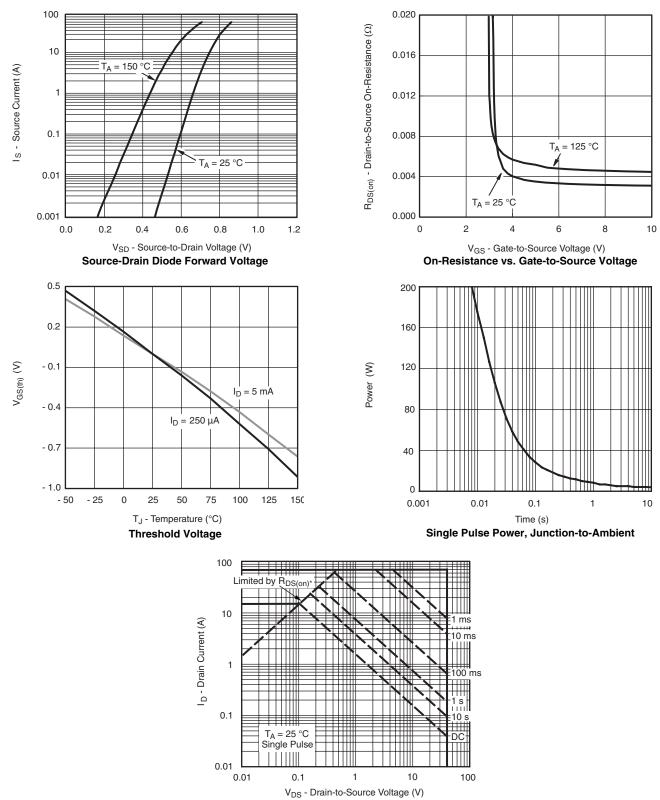
Document Number: 73852 S09-0138-Rev. B, 02-Feb-09

**Gate Charge** 

**On-Resistance vs. Junction Temperature** 

150

#### **TYPICAL CHARACTERISTICS** $T_A = 25 \text{ °C}$ , unless otherwise noted

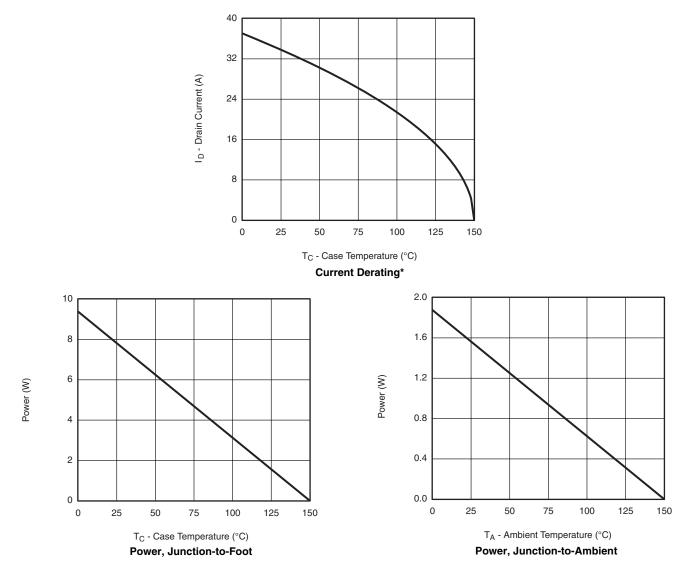


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified Safe Operating Area, Junction-to-Ambient

SHA



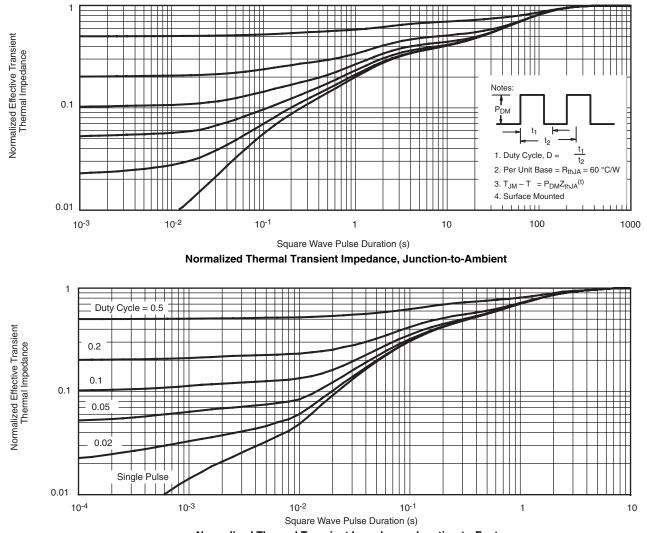
**TYPICAL CHARACTERISTICS**  $T_A = 25 \text{ °C}$ , unless otherwise noted



\* The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### **TYPICAL CHARACTERISTICS** $T_A = 25 \text{ °C}$ , unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73852">www.vishay.com/ppg?73852</a>.



# Package Information

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### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





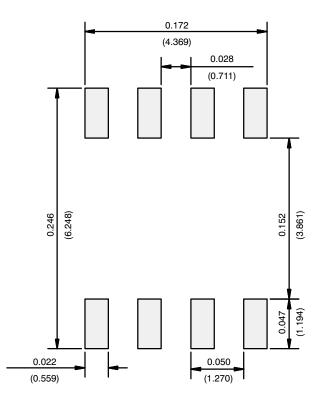
	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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